

# IEEE 1588 & Synchronous Ethernet Packet Clock Network Synchronizer

## Features

- Up to four independent clock channels
- Fully compliant to EEC (G.8262), SEC (G.813), GR-253 SMC and GR-1244 Stratum 3/3E
- Frequency accuracy performance for GSM, WCDMA-FDD, LTE-FDD basestations and small cell applications, with target performance less than  $\pm 15$  ppb.
- Frequency performance for ITU-T G.823 and G.824 synchronization interface, as well as G.8261 PNT EEC, PNT PEC and CES interface specifications.
- Phase Synchronization performance for WCDMA-TDD, TD-SCDMA, CDMA2000, LTE-TDD and LTE-A applications with target performance less than  $\pm 1 \mu\text{s}$  phase alignment.
- Client holdover and reference switching between multiple Servers
- Support for new ITU-T packet clock recommendations or drafts: G.8263 PEC-S, G.8273.2 T-BC, T-TSC, G.8273.4 T-BC-P, T-TSC-P & T-TSC-A

## Ordering Information

ZL30701LDG6*	100 Pin aQFN	Trays
ZL30702LDG6*	100 Pin aQFN	Trays
ZL30703LDG6*	100 Pin aQFN	Trays
ZL30704LDG6*	100 Pin aQFN	Trays
*Pb Free Tin/Silver/Copper		
Package size: 10 x 10 mm		
-40°C to +85°C		

- Excellent jitter performance of 180 fs rms (12 kHz to 20 MHz) meets 10G/40G and 100G PHY jitter requirements
- Up to four programmable digital PLLs/NCOs with loop bandwidth from 0.1 mHz to 470 Hz synchronize to any clock rate from 0.5 Hz to 900 MHz
- Automatic hitless reference switching and digital holdover on reference fail with initial holdover accuracy better than 0.1 ppb
- Any input reference can be fed with clock, sync (frame pulse), clock /sync pair or clock modulated with sync pulse (embedded PPS ePPS and embedded PP2S ePP2S)

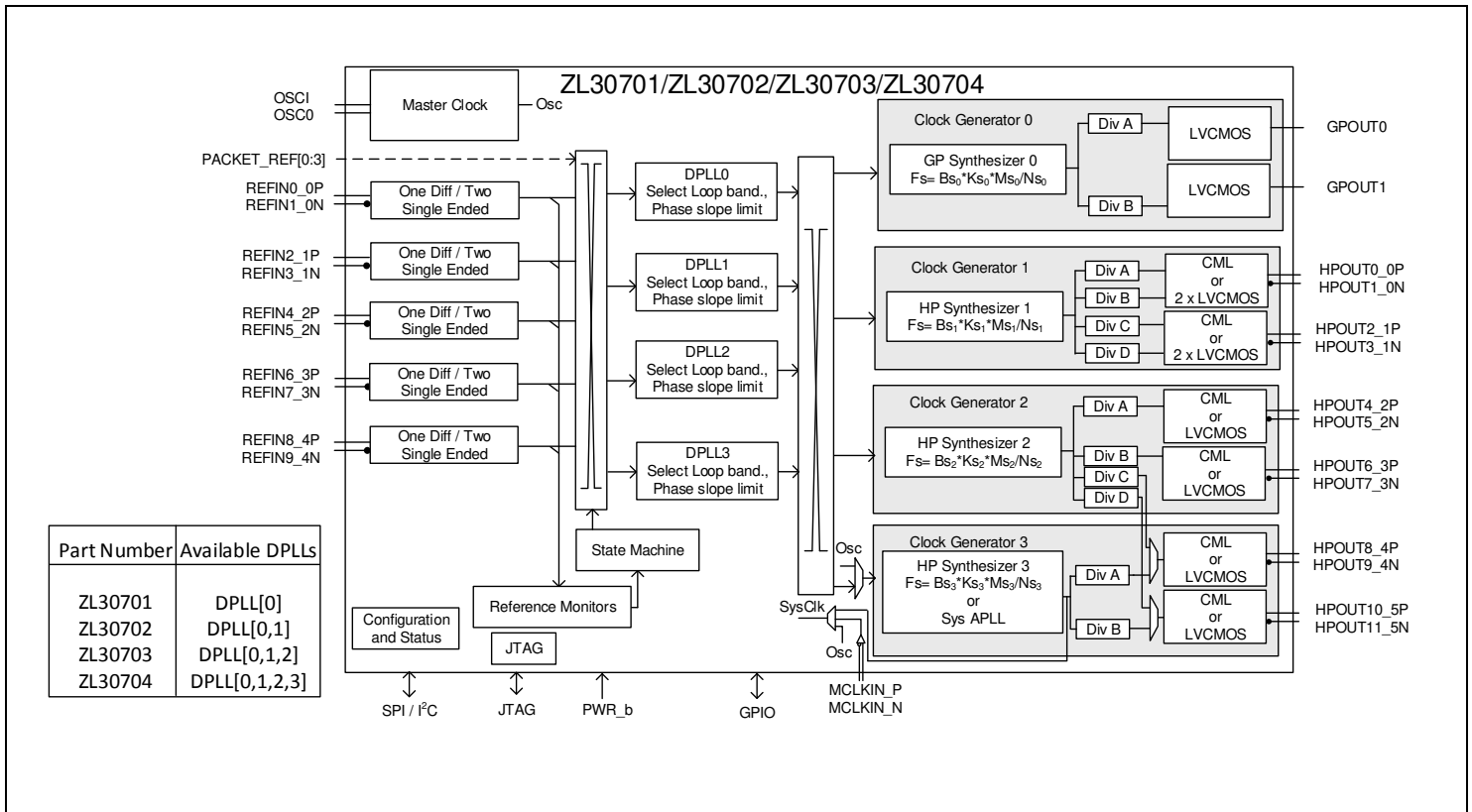


Figure 1. Functional Block Diagram

## 2 Feature List

### 2.1 General features

- Up to four independent clock channels
- Operates from a single crystal resonator or clock oscillator
  - Supports split XO mode for low-frequency stability TCXO/OCXO with ultra-low jitter clock outputs
- Configurable from SPI/I2C bus or from pre-configured flash memory

### 2.2 Electrical Clock Inputs

- Accepts up to 10 LVCMOS or 5 LVDS/HCSL/LVPECL/CML inputs
- Frequencies from 0.5 Hz to 180 MHz for LVCMOS
- Frequencies from 0.5 Hz to 900 MHz for LVDS/HCSL/LVPECL/CML
- Flexible input reference monitoring automatically disqualifies references based on frequency and phase irregularities.
  - Each input reference has its own set of monitors which can be independently programmed.
  - Loss of signal (LOS)
  - Single Cycle Monitor (Triggers on glitches or variation in duty-cycle)
  - Coarse Frequency Monitor
  - Precise Frequency Monitor
- Locks to gapped clocks

### 2.3 Electrical Clock Input-Output Special Formats

- Supports 64 kHz composite clocks with external glue logic
- Supports embedded pulse per second (ePPS) single wire for carrying high-speed clock & 1PPS
- Supports REF-SYNC pair, a combination of a high speed clock reference and a frame pulse sync pair
- Each output can generate clock, sync pulse, embedded pulse per second (ePPS) or embedded pulse per 2 seconds (ePP2S)
  - Clock modulated sync feature helps in reducing number of clock lines on backplane and in addition provides equal delay for both clock and sync signals.

### 2.4 Electrical Clock Engine

- Digital PLLs filter jitter from 0.1 mHz up to 470 Hz
- Multiple modes of operation
  - Freerun
  - Forced holdover
  - Forced reference
  - Automatic
  - NCO
- Internal state machine automatically controls state
  - Locked
  - Acquiring
  - Holdover
- Automatic hitless reference switching and digital holdover on reference fail
  - Physical-to-physical reference switching
  - Physical-to-packet reference switching
  - Packet-to-physical reference switching
  - Packet-to-packet reference switching
- Support for fast lock with lock times in seconds
- Support for hitless reference switching
- Internal, per DPLL, time of day counters maintaining full 48-bit seconds and 32-bit nanoseconds aligned to 1PPS rollover
- Holdover better than 0.01 ppb
- Full rate conversion between input and output clock frequencies
- Supports ITU-T G.823, G.824 and G.8261 for 2048 Kbit/s and 1544 Kbit/s interfaces
- Supports G.781 SETS

## 2.5 Electrical Clock Engine: Industry Specifications

- Support for wide variety of Equipment Clock specifications
  - SyncE
    - ITU-T G.8262 option 1 EEC (Europe/China)
    - ITU-T G.8262 option 2 (USA)
  - SONET/SDH
    - ITU-T G.813 option 1 SEC (Europe/China)
    - ITU-T G.813 option 2 (USA)
    - ANSI T1.105/Telcordia GR-253 Stratum 3 for SONET
    - Telcordia GR-253 SMC
  - PDH
    - ITU-T G.812 Type I SSU
    - ITU-T G.812 Type II, ANSI T1.101/Telcordia GR-1244 Stratum 2 (without optional freq monitoring at 16 ppb)
    - ITU-T G.812 Type III, ANSI T1.101/Telcordia GR-1244 Stratum 3E
    - ANSI T1.101/Telcordia GR-1244 Stratum 3
    - ANSI T1.101/Telcordia GR-1244 Stratum 4E/4

## 2.6 Electrical Clock Generation

- Four programmable synthesizers
- Precision Synthesizers
  - Each ultra-low jitter output can be independently set to be differential (CML) or two CMOS
  - Six CML outputs
    - Generate clock rates from 0.5 Hz to 900 MHz
    - Jitter performance of 180 fs rms (12 KHz – 20 MHz)
    - Meets OC-192, STM-64, 1 GbE & 10 GbE interface jitter requirements
  - Twelve LVCMOS outputs
    - Generate clock rates from 0.5 Hz to 180 MHz
    - Jitter performance of 290 fs rms (12 kHz – 20 MHz)
- General Synthesizer
  - Two LVCMOS outputs
  - Generate clock rates from 1 Hz to 180 MHz
  - Jitter performance of 17 ps rms (12 kHz – 20 MHz)
- Programmable output advancement/delay to accommodate trace delays or compensate for system routing paths
- Each output has its own power supply pin which can be hooked to 3.3V, 2.5V or 1.8V supplies. Outputs may be disabled to save power

## 2.7 Packet Synchronization

The Time Synchronization Algorithm is suitable for use in a wide variety of markets and applications, including the following IEEE 1588-2008 Profiles

- Annex J.3 Delay Request-Response Default Profile
- Annex J.4 Peer-to-peer Default Profile
- ITU-T G.8265.1 Telecom Profile for Frequency Synchronization
- ITU-T G.8275.1 Telecom Profile for Phase with Full Timing Support Networks
- ITU-T G.8275.2 Telecom Profile for Phase with Partial Timing Support Networks
- CableLabs CM-SP-RDTI Remote DTI Profile
- SMPTE ST-2059-2 Professional Broadcast Environment Profile
- IEEE C37.238 Standard Profile for Use of IEEE 1588 Precision Time Protocol in Power System Applications.
- IEC 61850-9-3 Power Utility Automation Profile
- IEEE802.1as AVB-TSN gPTP
- IEEE 1588-2018 Annex X High Accuracy Profile (based on White Rabbit)
- IETF TICTOC Enterprise Profile

### 2.7.1 Applications

The Time Synchronization Algorithm is suitable for many end application targets.

- Frequency accuracy performance for GSM, WCDMA-FDD, LTE-FDD femtocell, small cell (residential, urban, rural, enterprise), picocell and macrocell applications, with target performance less than  $\pm 15$  ppb.
- Frequency performance for ITU-T G.823 and G.824 synchronization interface, as well as G.8261 PNT EEC, PNT PEC and CES interface specifications.
- Phase Synchronization performance for WCDMA-TDD, Mobile WiMAX, TD-SCDMA, CDMA2000, LTE-TDD and LTE-A femtocell, small cell (residential, urban, rural, enterprise), picocell and macrocell applications with target performance less than  $\pm 1$   $\mu$ s phase alignment.
- Time Synchronization for TAI, UTC-traceability and GNSS/GPS replacement.

### 2.7.2 Packet Networks

The Time Synchronization Algorithm is suitable for high performance over a variety of packet networks

- ITU-T G.8261 Appendix VI
- ITU-T G.8261.1 network limit compliant
- ITU-T G.8271.1 network limit compliant
- ITU-T G.8271.2 (draft) network limit compliant
- Native Ethernet (switched) & IP (routed) networks
- xDSL
- Microwave
- Fully aware, partially aware and unaware timing supported networks
- Networks including intermediate Boundary Clocks and Transparent Clocks
- Networks with and without SyncE or frequency physical layer support

### 2.7.3 Clock Specifications

The Time Synchronization Algorithm is suitable to address a variety of standardized clock specifications, including

- ITU-T G.8263 PEC-S
- ITU-T G.8273.2 T-BC full on-path without SyncE
- ITU-T G.8273.2 T-BC full on-path with SyncE
- ITU-T G.8273.2 T-TSC full on-path without SyncE
- ITU-T G.8273.2 T-TSC full on-path with SyncE
- ITU-T G.8273.4 T-BC-P (draft)
- ITU-T G.8273.4 T-TSC-A (draft)
- ITU-T G.8273.4 T-TSC-P (draft)

### 2.7.4 Monitoring & Redundancy

The Time Synchronization Algorithm includes monitoring & redundancy for high availability synchronization, including

- Synchronization to the best available Server
- Client monitoring of secondary Server references
  - Monitoring includes full time synchronization reporting of secondary Server
  - Supports a programmable number of secondary Server connections
- Hitless reference switching between multiple Servers
- Holdover when Server packet connectivity is lost
- TIE clear option to build out, or clear, phase offsets between Server references

### 2.7.5 General

The Time Synchronization Algorithm includes many advanced features to aide in the high-accuracy & high-stability applications, including

- Full PLL state machine (Freerun, Holdover, Frequency Lock Acquiring, Frequency Lock Acquired, Phase Lock Acquired), with programmable thresholds for state transitions
- Programmable bandwidth configurability from sub-mHz to 100's of mHz.
- Programmable packet rates from 1 packet/second to over 128 packets/second
- User ability to manually add frequency offsets due to temperature or ageing (especially during holdover state)

### 3 Application Examples

The only difference between ZL30701/ZL30702/ZL30703/ZL30704 is the number of DPLLs. The least significant digit in the part number assigns the number of available DPLLs.

#### 3.1 Packet Layer - Centralized Architecture

A typical ZL30701/ZL30702/ZL30703/ZL30704 application is IEEE1588 time synchronization with centralized architecture shown in Figure 2. The application has three distinct modules: Ethernet PHY/MAC with timestamp capability, Host processor running IEEE1588 protocol and Microsemi Time Sync Frequency and Phase algorithm and the ZL30701/ZL30702/ZL30703/ZL30704 Synchronous Ethernet and IEEE1588 Packet Clock Network Synchronizer. Although Figure 2 shows a single board application commonly known as “Pizza Box”, the same type of architecture would be used in shelf based systems. Shelf based systems would have ZL30701/ZL30702/ZL30703/ZL30704 populated on active and redundant timing card and Ethernet PHY/MACs would be placed on line cards.

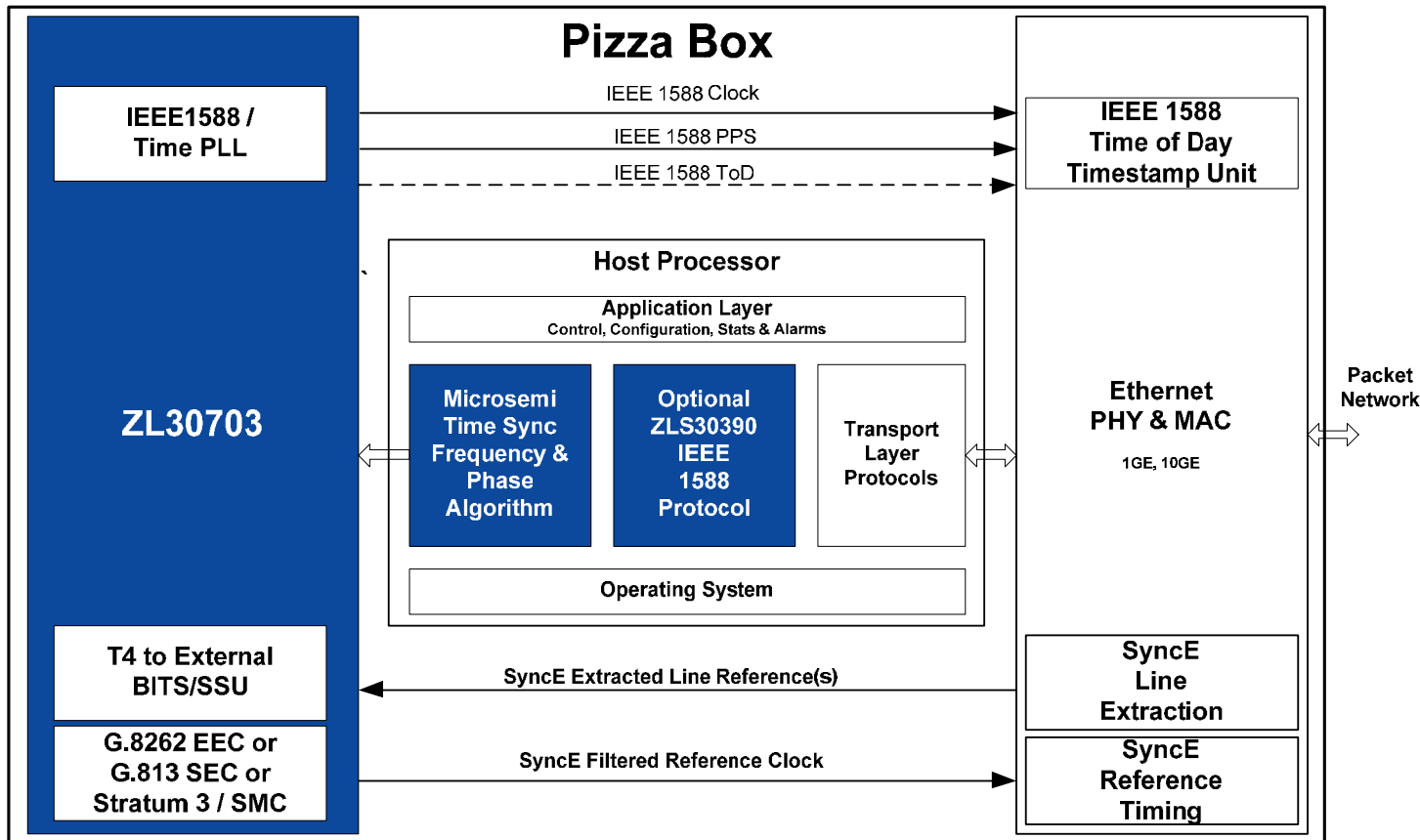


Figure 2. IEEE1588 Time Synchronization with Centralized Architecture

### 4 Product Family

There are several devices within the ZL30701/702/703/704 family. They are differentiated by the number of DPLL, as shown in

Table 1 · ZL3070x Product Family

Product Number	Number of DPLL Channels	Number of Synthesizers
ZL30701	1	4
ZL30702	2	4
ZL30703	3	4
ZL30704	4	4

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